## R263-Z37-AAC1

Rack Server - 2U UP 12+2-Bay Gen5 NVMe/SATA/SAS-4 Platinum





## **Key Features**

- Single AMD EPYC<sup>™</sup> 9005/9004 Series Processors
- 12-Channel DDR5 RDIMM, 12 x DIMMs
- Dual ROM Architecture
- 1 x 1Gb/s LAN port via Intel® I210-AT
- 4 x 3.5"/2.5" Gen5 NVMe/SATA/SAS-4 hot-swap bays
- 8 x 3.5"/2.5" SATA/SAS-4 hot-swap bays
- 2 x 2.5" Gen5 NVMe hot-swap bays on the rear side
- 1 x M.2 slot with PCIe Gen3 x4 interface
- 4 x FHHL PCIe Gen5 x16 slots
- 2 x OCP NIC 3.0 PCIe Gen5 x16 slots
- 1+1 1300W 80 PLUS Platinum redundant power supplies

## **Applications**

Networks Server, Servers for Hybrid/Private Cloud...

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Dimensions	2U (W438 x H87.5 x D710 mm)	PCIe Expansion Slots	4 x FHHL PCIe Gen5 x16 2 x OCP NIC 3.0 PCIe Gen5 x16, Support NCSI		
Motherboard	MZ33-DC1	I/O Ports	Front:		
CPU	AMD EPYC <sup>™</sup> 9005 Series Processors  AMD EPYC <sup>™</sup> 9004 Series Processors  Single processor, cTDP up to 400W  - At 25°C ambient, cTDP up to 500W	I/O Puits	2 x USB 3.2 Gen1  Rear: 2 x USB 3.2 Gen1, 1 x Mini-DP, 1 x RJ45, 1 x MLAN		
	- At 30°C ambient, cTDP up to 500W with optional heatsink	Backplane Board	Front - CBP20C7: PCle Gen5 x4 or SATA 6Gb/s or SAS-4 24Gb/s Rear - CBP2025: PCle Gen5 x4		
OS Compatibility	OS Support List	TPM	1 x TPM header (SPI), Optional TPM2.0 kit: CTM012		
Socket Chipset	1 x LGA 6096 (Socket SP5)  System on Chip	Power Supply	1+1 1300W 80 PLUS Platinum redundant power supplies AC Input: 100-240V		
Memory	12-Channel DDR5 RDIMM, 12 x DIMMs [EPYC 9005] Up to 6400 MT/s [EPYC 9004] Up to 4800 MT/s	System Management	ASPEED® AST2600 Baseboard Management Controller GIGABYTE Management Console web interface		
		System Fans	4 x 80x80x38mm		
LAN	1 x 1Gb/s LAN (1 x Intel <sup>®</sup> I210-AT), Support NCSI 1 x 10/100/1000 Mbps Management LAN	Operating Properties	Operating: 10°C to 30°C, 8% to 80% (non-condensing) Non-operating: -40°C to 60°C, 20% to 95% (non-condensing)		
Video	Integrated in ASPEED® AST2600 - 1 x Mini-DP	Packaging Content	1 x R263-Z37-AAC1 1 x CPU heatsink 1 x Mini-DP to D-Sub cable 1 x 2-Section Rail kit		
Storage	Front hot-swap: 4 x 3.5"/2.5" Gen5 NVMe/SATA/SAS-4 <sup>[1]</sup> 8 x 3.5"/2.5" SATA/SAS-4 <sup>[2]</sup>				
	Rear hot-swap: 2 x 2.5" Gen5 NVMe [3] Internal M.2:	Ordering Part Numbers	With default heatsink: 6NR263Z37DR000ACC1* With optional heatsink: 6NR263Z37DR000ADC1*		
	1 x M.2 (2280/22110), PCIe Gen3 x4  [1] Storage card is required to support SATA and SAS drives.  [2] SAS card is required to support SAS drives.  [3] NVMe supported only.	Optional Parts	<ul> <li>3-Section Rail kit (Supports CMA): 25HB2-A56121-K0R</li> <li>Cable Management Arm: 25HB1-R18300-K0R</li> <li>CPU heatsink (500W, 30°C ambient): 25ST1-563400-C1R</li> </ul>		
RAID	Require RAID add-in cards				



